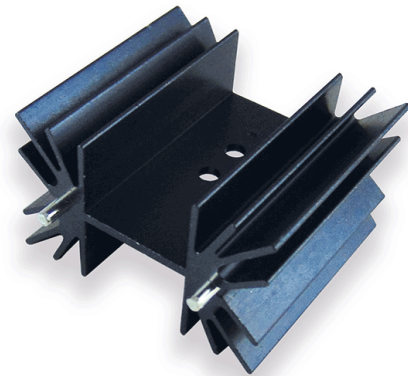


Product Data Sheet Type: PR33/38,1/SE

Group: HEATSINKS Board Level

For single mounting

Width : 42 mm
 Height : 25 mm
 Length : 38.1 mm
 Minimum thermal resistance : 5 K/W
 For device : TO 220|TO 218|TOP 3
 Device mounted by : Screw
 Heatsink mounted by : Solder
 Surface : Black Anodised
 Material : AlMgSi0,5



- Special extruded heatsink for semiconductor case TO220, TO218(TOP3)
- Aluminium, anodised black, solderable
- Standard heights: 25.4, 38.1, 50.8 and 63.5 mm
- 2 x 3.2 mm holes for semiconductor assembly
- Heatsink solderable by tin plated solder pins

